

## GAMING PERFORMANCE BUNDLES PACK

TAIWAN  
EXCELLENCE  
2017

T-Force | Bundles pack

# T-FORCE

## GAMING BUNDLES PACK

**The all new gaming style heat spreader from Dark Pro interprets the high speed spirit of the T-Force series perfectly**

Dark Pro is the product of Team Group's T-Force series that is specifically designed for people who pursuit extreme high speed and excellent performance. The 2016 Dark Pro evolves again and releases an all new specification. The appearance design is also completely different from the previous low key style. The all new designed heat spreader interprets the high speed spirit of the T-Force series perfectly.

**Design to completely cover the top and both sides of the heat spreader**

The solid texture of Dark Pro is continued and even further enhanced. A three-piece heat spreader with top and two sides completely covered, not only can enhance the radiating performance and maintain the system a long time stable operation, but also can solve the problem of overheating.



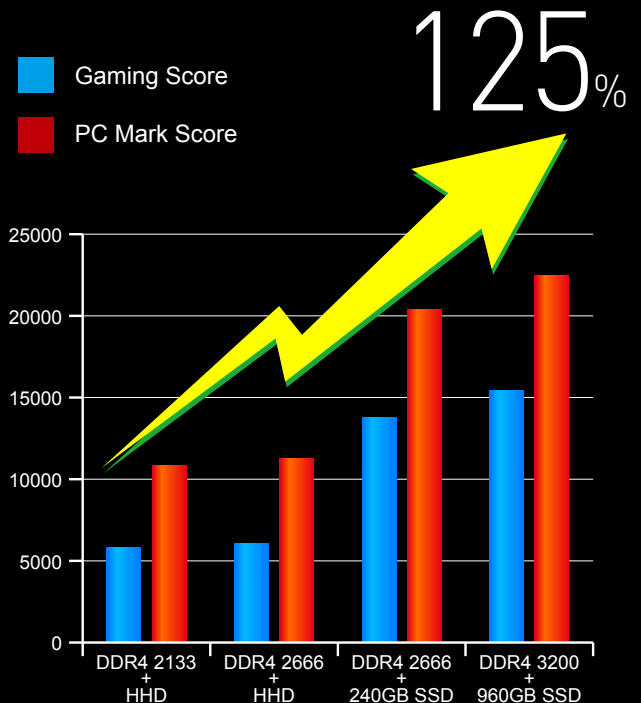
## With one from purchase to satisfy every single need

Most packages on the market contain keyboard and gaming mouse. Team Group is the first company to combine overclocking memory module and solid state drive into a high performance gaming combo package, so users can have both high frequency memory and large capacity solid state drive at the same time. With only single purchase, users can satisfy all their requirements and improves the smoothness of the game without having to worry about computer compatibility issues.



**High speed performance is enhanced up to 125% with ultra-high specification**

The high speed gaming combo package is able to meet the requirements for high speed transfer and multimedia storage. Features low power consumption, silent operation, shockproof and low heat. It is both energy saving and environmentally friendly. After testing, the combination of a computer with the high performance gaming combo package and a standard memory module with a hard drive is able to improve computer performance by up to 125%.



## QVL approved by motherboard manufacturers

Multiple compatibility verifications with mainstream DDR4 motherboards to make sure its stability with all motherboards on the QVL(Qualified Vendor List). Therefore, you wouldn't have to worry about compatibility issues when purchasing high speed memory.



## XMP2.0 1 step overclocking technology

All series support Intel XMP 2.0. It is only one step away to experience the high speed sensation of overclocking.



# Main Feature

- The exclusive approved pattern gaming bundle pack
- With one from purchase to satisfy every single need
- High speed performance is enhanced up to **125%** with ultra high specification
- 1.2V / 1.35V ultra low working voltage
- Support intel XMP 2.0 smart overclocking technology
- Selected high quality IC chips
- QVL approved by mainstream motherboard manufactures in the market
- Taiwan Utility PATENT (number: M533767)



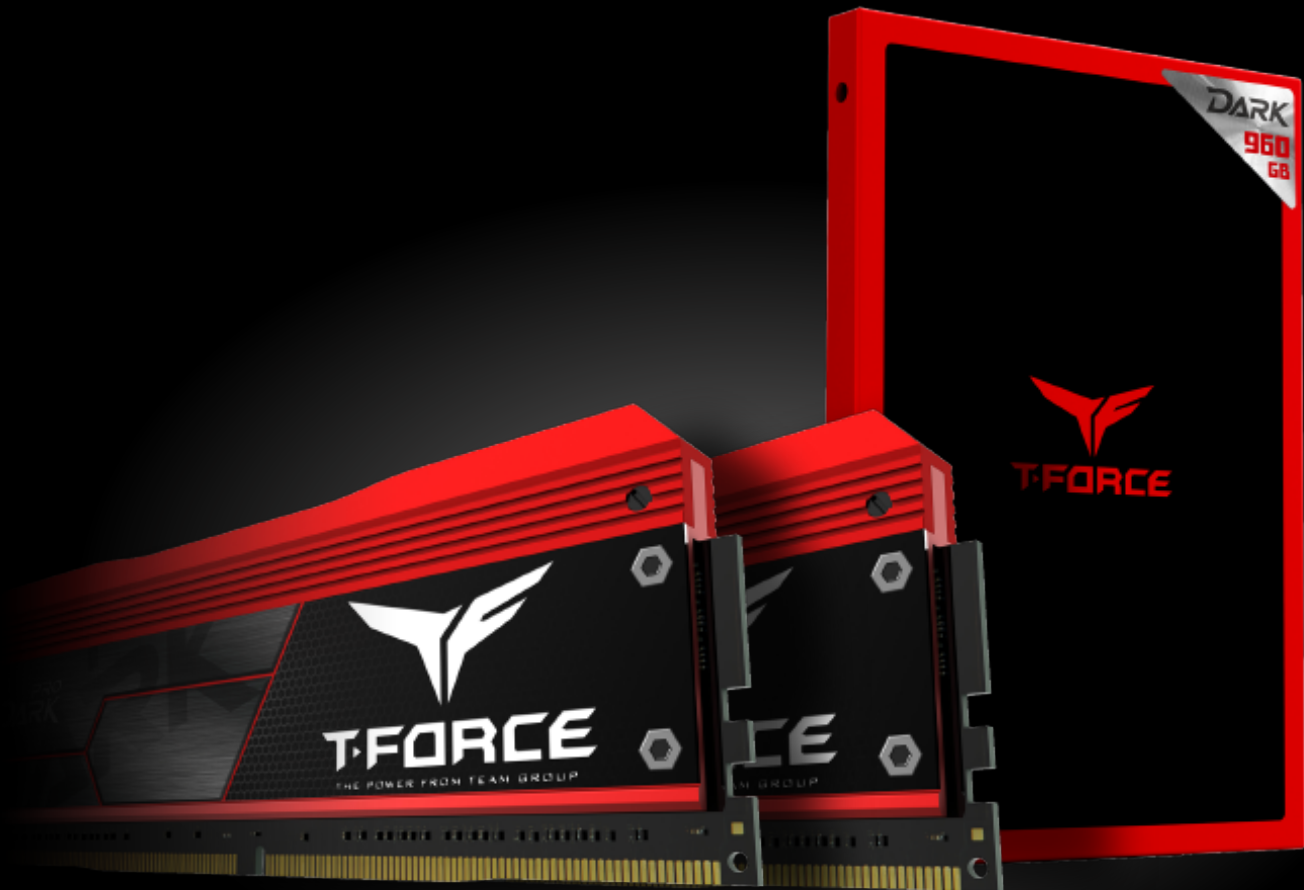
# Specification

Item (Module)	Specification		
Module Type	288 Pin Unbuffered DIMM Non ECC		
Capacity	8GBx2	8GBx2	16GBx2
Frequency	2666	3000	3200
Data transfer bandwidth	21,300 MB/s(PC4 21300)	24,000 MB/s(PC4 24000)	25,600 MB/s(PC4 25600)
CL-value	CL15-17-17-35	C16-18-18-38	C15-15-15-35
Working voltage	1.2V	1.35V	
Heat Spreader	Aluminum heat-sink		
Operation System	A Computer with DDR4 Dimm slots and SATA ports function normally : Windows 10 / 8.1 / 8 / 7 / Vista / XP		
Warranty	Lifetime Warranty		

Item (SSD)	Specification		
Solution	MLC		
Capacity	240GB	480GB	960GB
Interface	SATA Rev. 3.0 (6Gb/s) – with backwards compatibility to SATA Rev. 2.0		
Performance	ATTO : 240GB Read/Write: up to 520/300 MB/s* 480GB Read/Write: up to 520/460 MB/s* 960GB Read/Write: up to 520/460 MB/s*	IOPS: 240GB 4K Random Read/Write: 75K/75K IOPS Max* 480GB 4K Random Read/Write: 75K/75K IOPS Max* 960GB 4K Random Read/Write: 75K/75K IOPS Max*	
Warranty	3 years		

# Ordering Information

Description	Color	Timings/Voltage	Capacity	Team P/N
TEAM BUNDLES UD-D4 2666+240GB	Red/Black	CL15-17-17-35 1.2V	8GBx2	TBD416G2666HC15BDC-240G01
TEAM BUNDLES UD-D4 3000+480GB		CL16-18-18-38 1.35V	8GBx2	TBD416G3000HC16CDC-480G01
TEAM BUNDLES UD-D4 3200+960GB		CL15-15-15-35 1.35V	16GBx2	TBD432G3200HC15ADC-960G01



Above technical information is based on industry standard data and tested to be reliable. However, Team makes no warranty, either expressed or implied, as to its accuracy and assumes no liability in connection with the use of this product.

Team reserves the right to make changes in specifications at any time without prior notice.